



Powering Innovation That Drives Human Advancement

AI-Powered Advancements in Ansys offering

Felipe Mercado – Lead Application Engineer

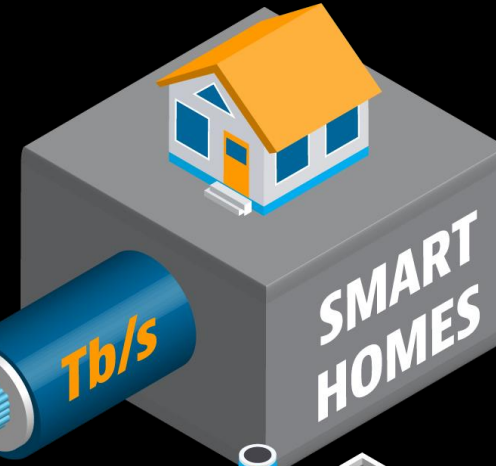
Photonics for AI

Medical imaging, sensing and diagnostics, lab on a chip, ...



HEALTH CARE

Consumer electronics, smart phone sensors, IoT home sensors, displays, ...



SMART HOMES

5G/6G, Optical communications, analog & RF systems, structural & environmental sensors, autonomous vehicle navigation (LIDAR), ...



INFRASTRUCTURE & SECURITY



DATA CENTERS

Tb/s

Industrial IoT, industrial chemical & environmental sensing, ...



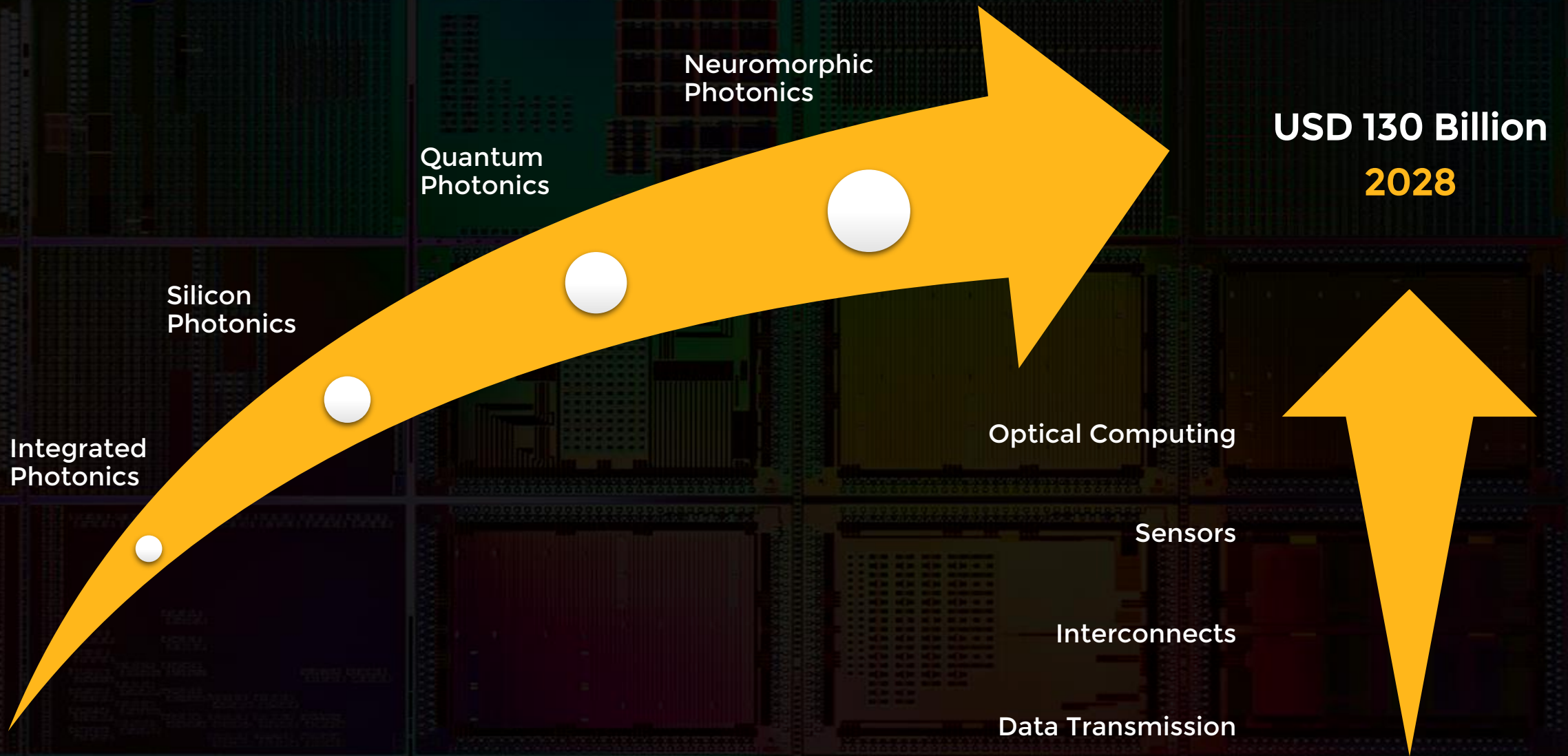
INDUSTRIAL IoT

Photonics for AI

Photonics provide the optical components and technologies needed for data transmission, sensing, and processing, enabling **AI** systems to efficiently handle large volumes of data.

AI algorithms leverage **Photonics** technology to optimize optical components and systems, enhancing performance and enabling intelligent decision-making in **Photonics** applications.

Photonics for AI



Product development challenges continue to grow



Rapid
technological
advancements

The panel features a dark blue background with a network of glowing nodes and lines, symbolizing technology and innovation.

Leaders must keep up with emerging technologies **disrupting traditional design process**



Systems are
increasingly
complex

The panel features a dark blue background with binary code (0s and 1s) and abstract circuit-like patterns, representing complex systems.

Requiring **multidisciplinary collaboration** – often times with globalized engineering & design teams



Design for RfQ,
sustainability &
compliance

The panel features a green background with icons for a wind turbine, a recycling symbol, and a scale of justice, representing sustainability and compliance.

Engineers must **consider factors across the lifecycle upfront**, while ensuring compliance with governing bodies

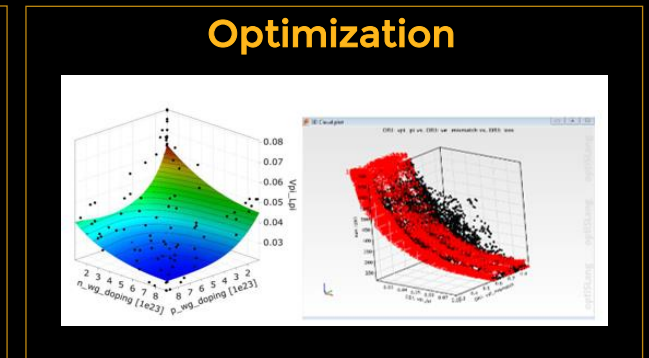
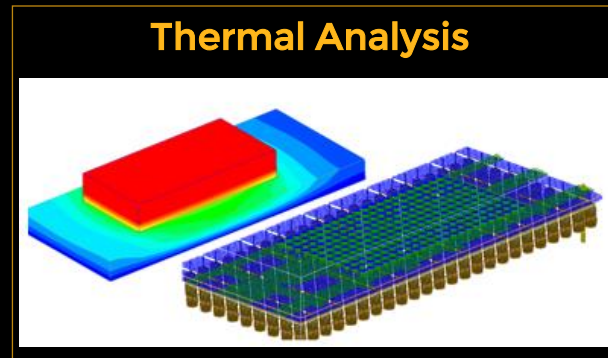
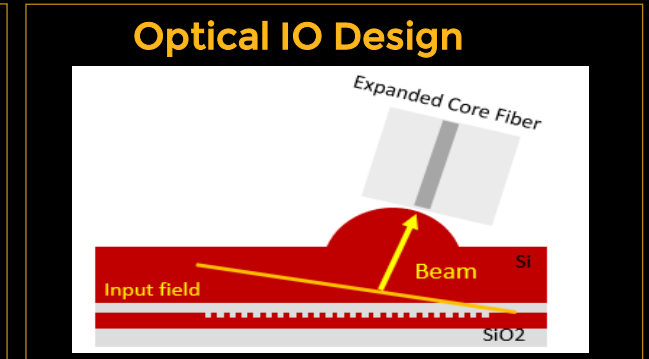
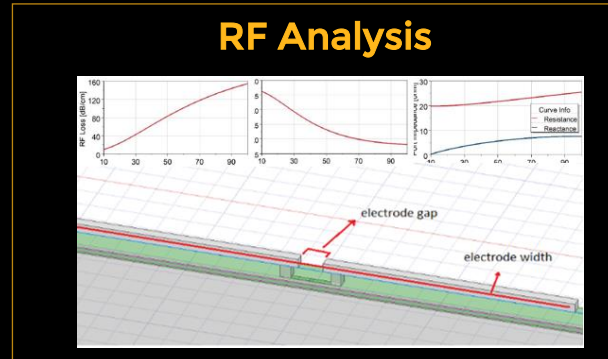
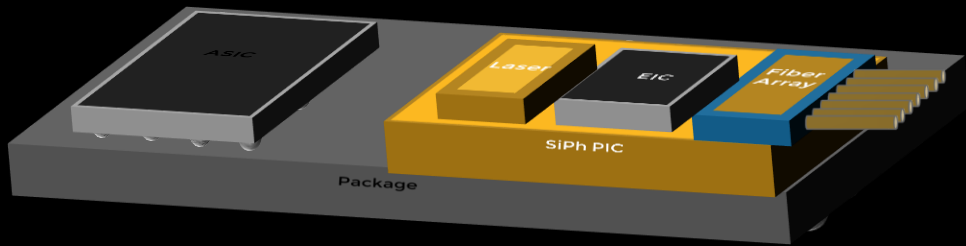
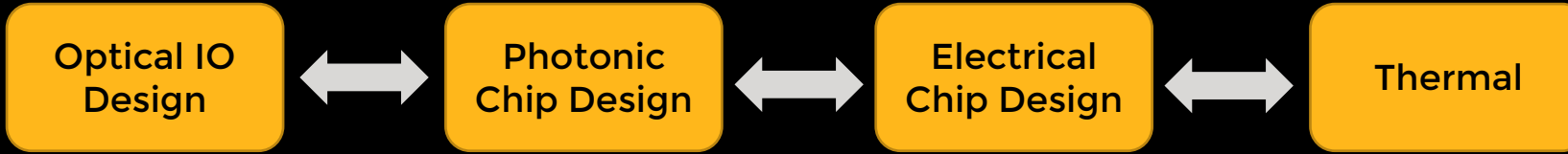


Increasing pressure
from your
stakeholders

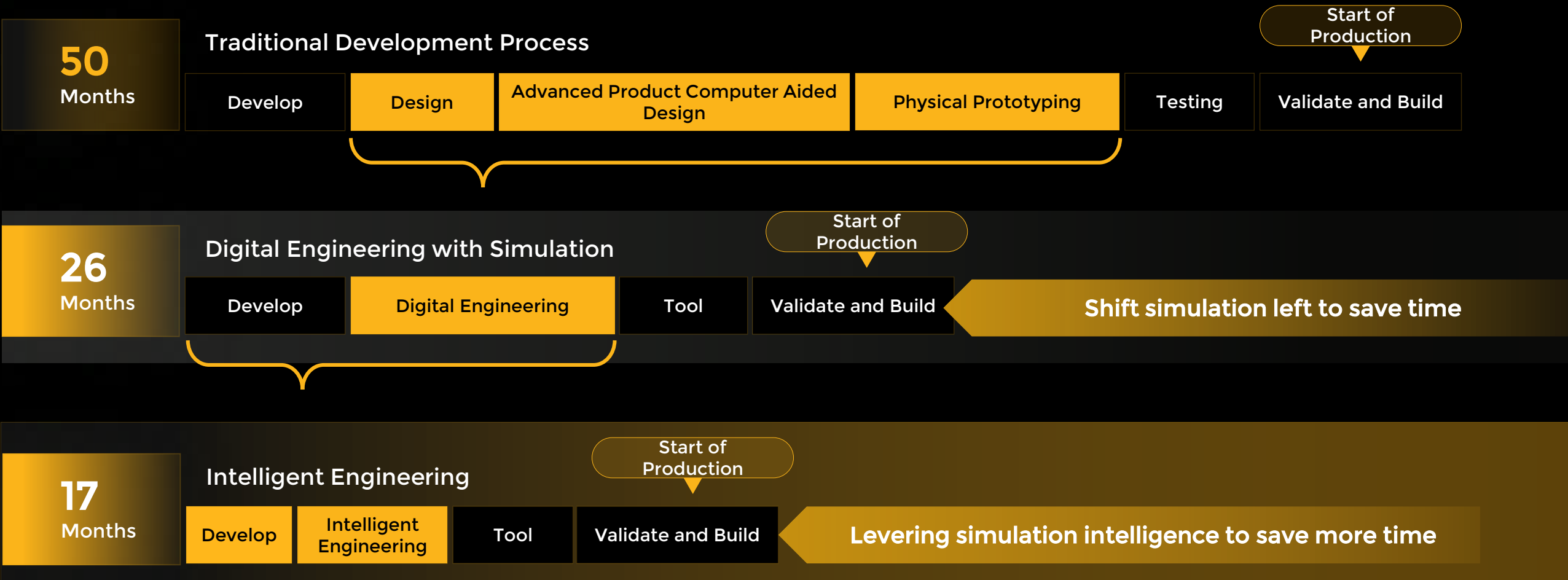
The panel features a light blue background with a red arrow pointing upwards and silhouettes of people, representing stakeholder pressure.

Pressure to make a better product: cheaper and faster

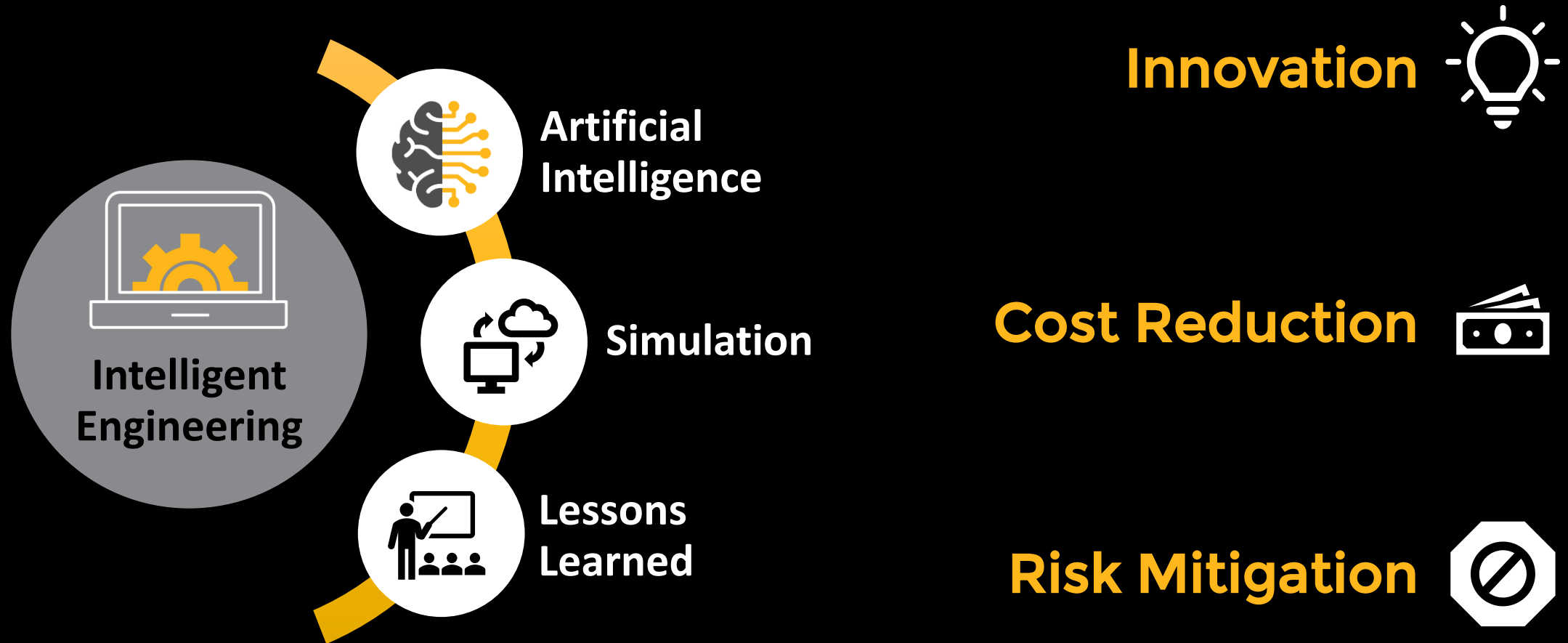
Co-packaged optics challenges



Achieving more with less



Intelligent Engineering: Shaping the Future



AI is transforming **simulation** by **automating** tasks, **optimizing** designs, and **democratizing** access to **advanced** modeling techniques, **accelerating** **innovation** and **efficiency** in the product development process.

Democratizing Simulation: Making it Accessible to All



Ansys AI – Transforming Simulation at the Speed of AI

Ansys AI+

AI Add-ons to Ansys products across portfolio

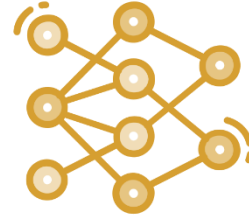


AI Add-ons to various Ansys simulation products that enhance simulation

Various Improvements

Ansys SIMAI

ML platform for simulation across the physics



Extremely fast and accurate physics predictions which learns from existing data

10x to 1000x Faster

Ansys Intelligence

Democratizing simulation insights



Hyper automation and accessibility through AI-trained optimization apps

Simple & Natural UX

Ansys GPT

Virtual assistant to Ansys products



Natural language assistant for documentation, training

Simple & Natural UX

Material Intelligence

	Time per Step (minutes)		Memory (GB)	
	Value	Range	Value	Range
Direct	28.1	16.8 - 49.1	95	66 - 142
Iterative	13.8	8.3 - 24.2	57	40 - 85

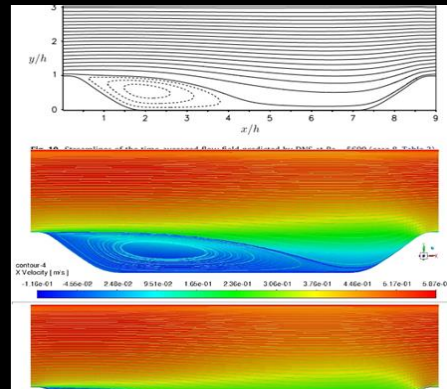
Resource Prediction

3D MOP

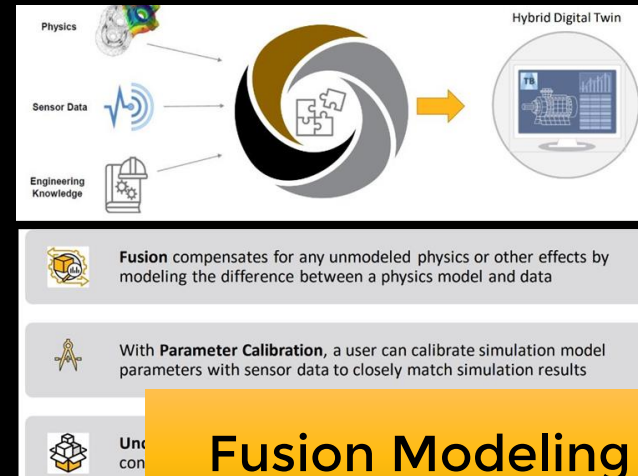
LES Reference

GEKO Default

Neural Network Augmented GEKO



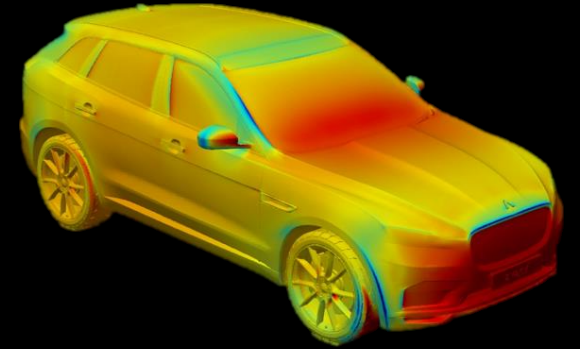
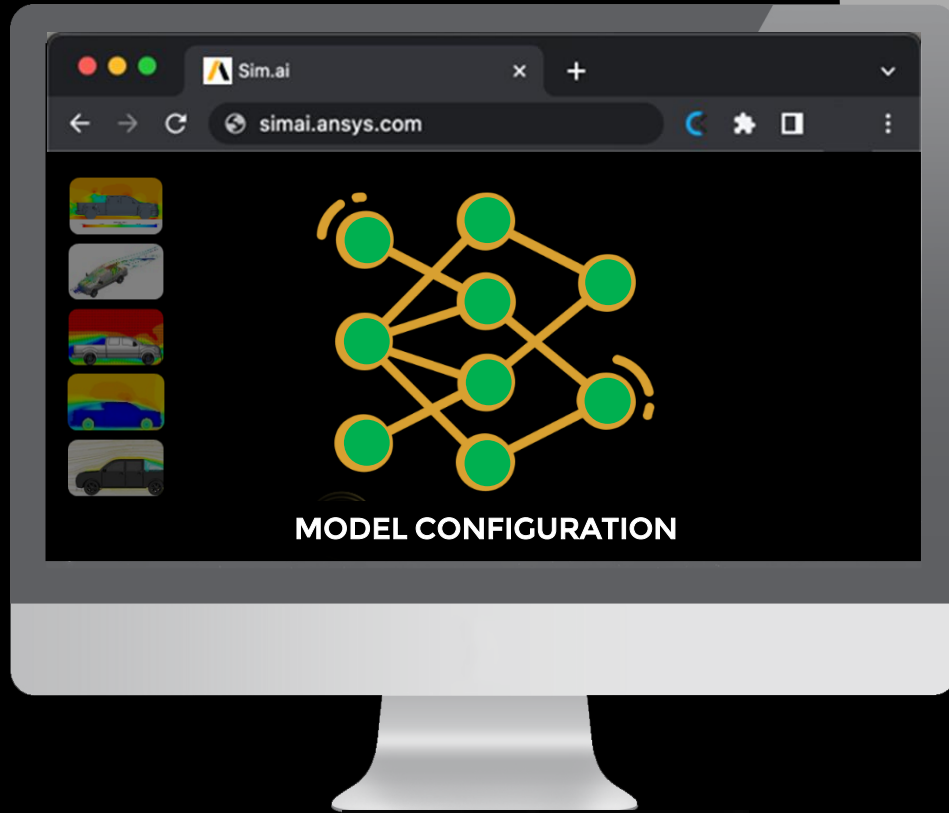
ML-based Simulation Tuning



Fusion Modeling



New Design



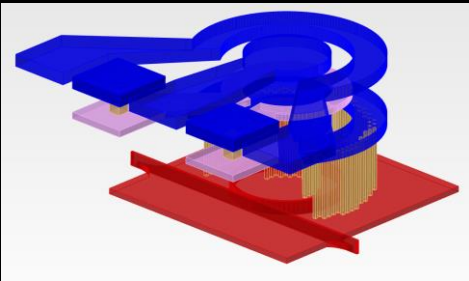
Performance Prediction
Fast. Reliable. Accessible.

1- UPLOAD
Your Past Data

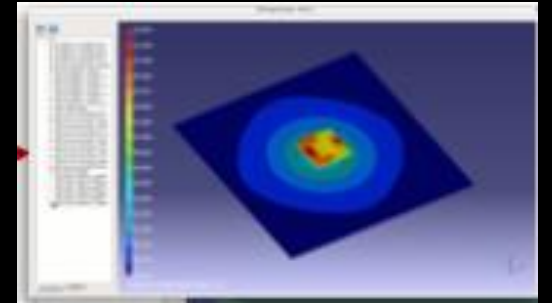
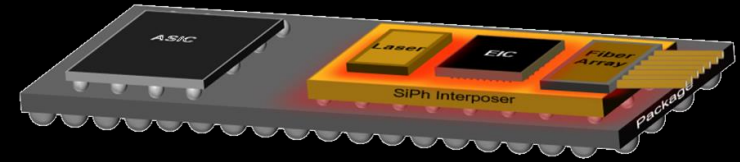
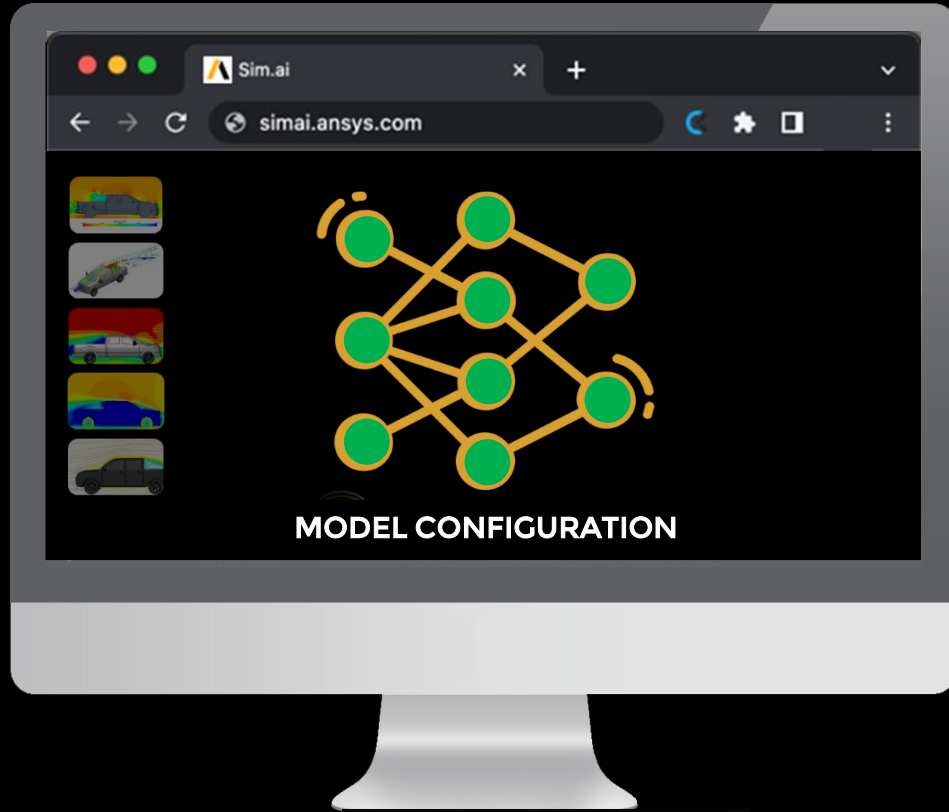
2- TRAIN
Your AI Model

3- PREDICT
In Seconds

model		Model
materials		Material Group
Ma	Si (Silicon)	Material Object
Ct	Si (Silicon)	Semiconductor
Ht	Si (Silicon)	Solid
Ma	SiO2 (Glass) - Sze	Material Object
Ct	SiO2 (Glass) - Sze	Insulator
Ht	SiO2 (Glass) - Sze	Solid



New Design



Performance Prediction
Fast. Reliable. Accessible.

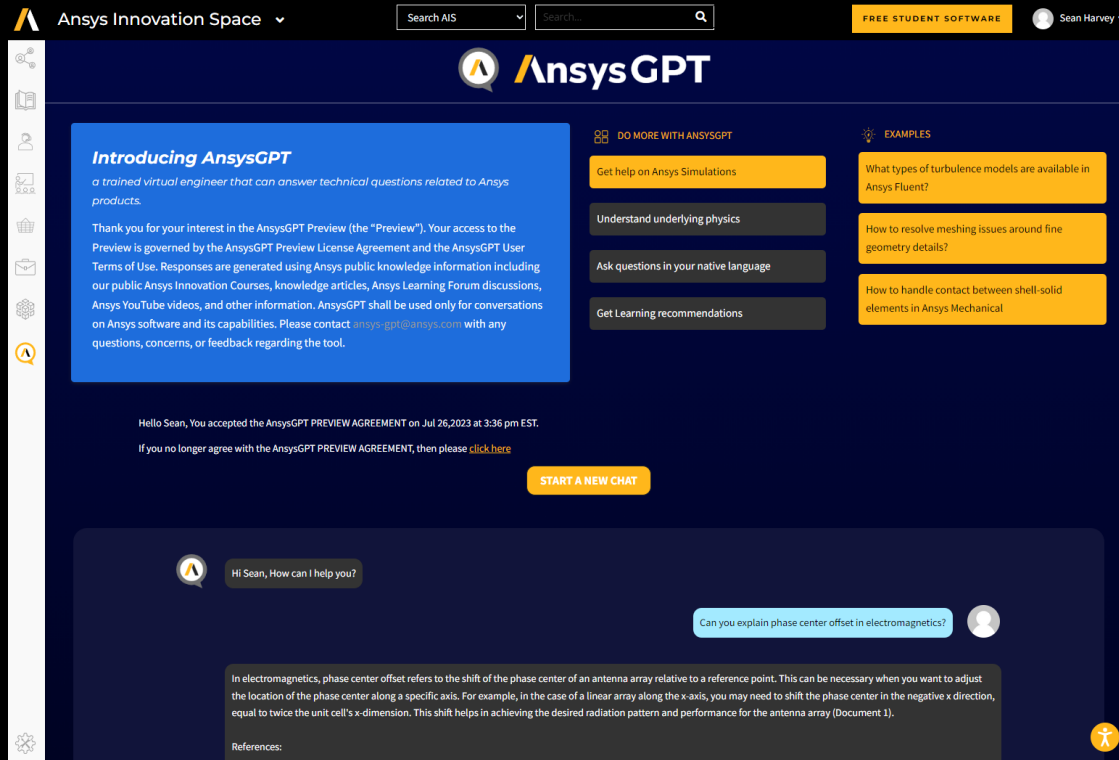
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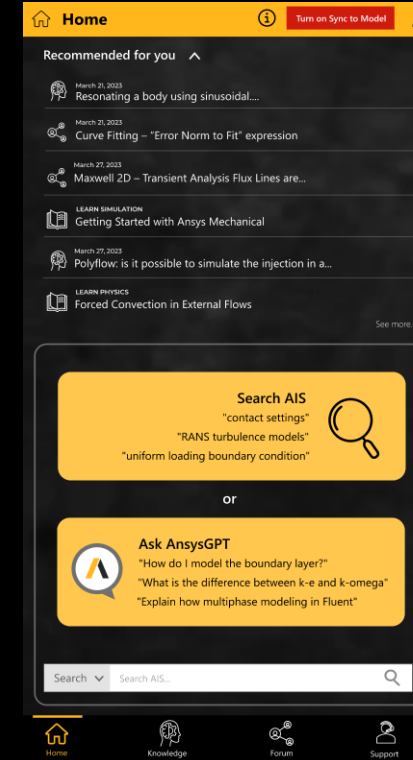
/ Desktop Version

Easily integrate into any platform



/ Mobile Version

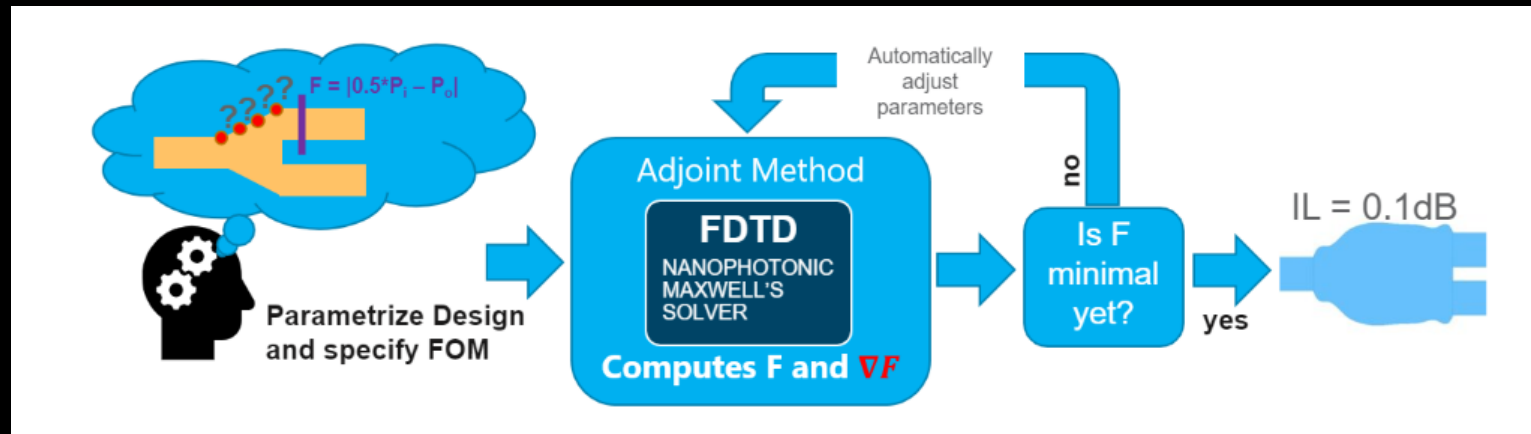
Easily integrate into any Ansys product



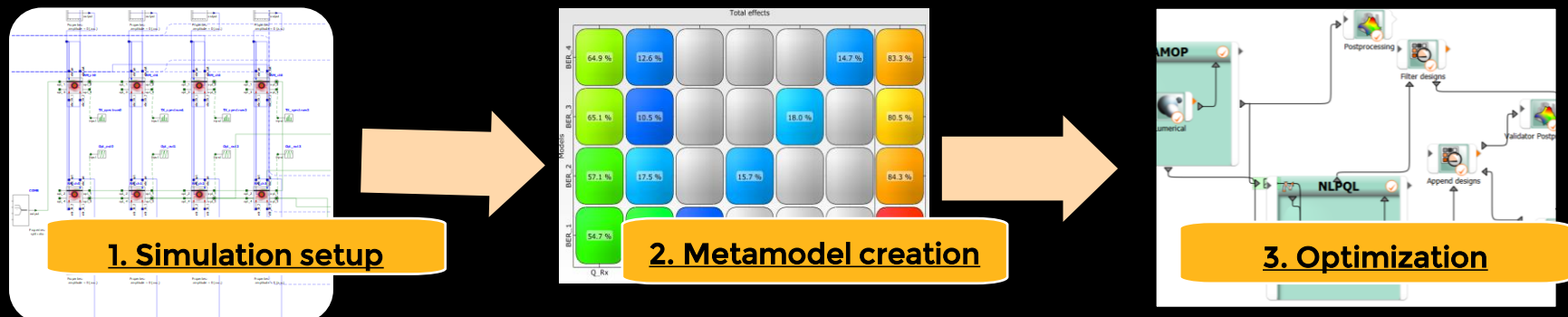
Optimizing Photonic Devices

- Go beyond validating designs and simple design variations
- Use advanced algorithms to explore many dimensional design spaces
- Understand parameter sensitivities and impact on yield

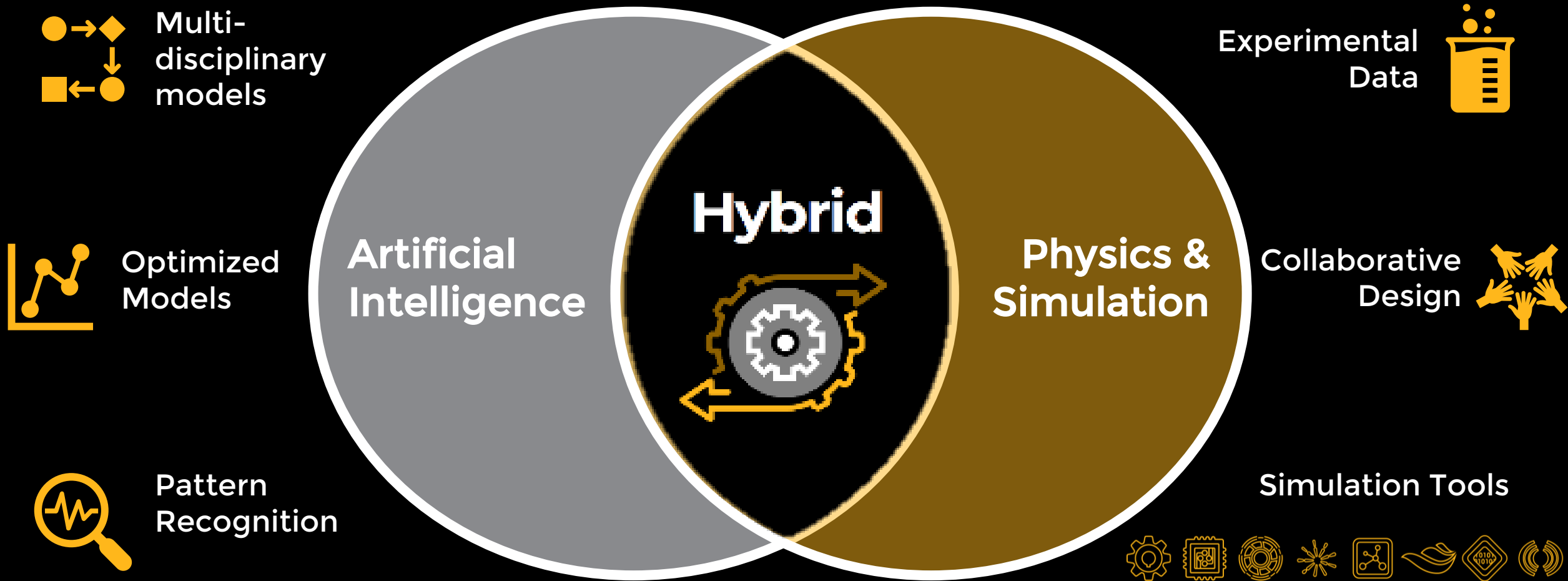
Example 1: Inverse design

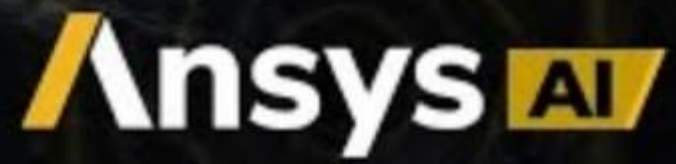


Example 2: Optimize metamodel



The Future of Simulation: Evolution and Innovation



The logo for Ansys AI is centered in the image. It features the word "Ansys" in a white, sans-serif font, with a yellow diagonal slash to its left. To the right of "Ansys" is the letters "AI" in a white, sans-serif font, enclosed within a yellow rectangular box with a diagonal slash on its right side. The background is a dark, abstract composition of glowing blue and yellow lines, resembling a complex circuit board or a neural network, with a large yellow triangular shape in the top right corner.

Ansys AI